

EM907 Solder Paste

Lead-Free, No-Clean

Product Description

EM907 is a lead-free, air and nitrogen reflowable no-clean solder paste specifically designed for the thermal requirements of lead-free alloys, including the Sn96.5Ag3.0Cu0.5 alloy. The paste flux system allows joint appearances that closely resemble that achieved with SnPb alloys. EM907 is capable of stencil printing downtimes up to 60 minutes with an effective first print down to 20 mils without any kneading. EM907 also exhibits excellent continual printability for fine pitch (0.4 mm/16 mils) and is able to print at high speeds up to 6 in/s (150 mm/s).

Performance Characteristics:

- Lead-free joints that closely resemble those achieved with SnPb solder paste
- Excellent solderability to a wide variety of surface metalizations, including NiAu, ImSn and ImAg
- High print speeds up to 150 mm/s
- Capable of 60 minute break times in printing
- Stencil life: 12+ hours (process dependent)
- Excellent printing characteristics to 16 and 20 mils pitch
- Excellent print and reflow characteristics for 0201 applications
- Stable tack life
- Classified as ROL1 per J-STD-004, J-STD-004A & J-STD-004B

Standard Applications:

88.5% Metal: Stencil Printing

RoHS Compliance

This product meets the requirements of the Restriction of Hazardous Substances (RoHS) Directive, 2015/863 for the stated banned substances.

Physical Properties

(Data given for Sn96.5Ag3.0Cu0.5, 88% metal, -325+500 mesh)

Viscosity (typical): 1800 poise

Malcom Viscometer @ 10 rpm and 25 °C





TECHNICAL DATA SHEET

Initial Tackiness (typical): 44 grams Tested to J-STD-005, IPC-TM-650, Method 2.4.44

Slump Test: Pass Tested to J-STD-005, IPC-TM-650, Method 2.4.35

Solder Ball Test: Preferred

Tested to J-STD-005, IPC-TM-650, Method 2.4.43

Wetting Test: Pass Tested to J-STD-005, IPC-TM-650, Method 2.4.45

Reliability Properties

Copper Mirror Corrosion: Low

Tested to J-STD-004, IPC-TM-650, Method 2.3.32

Corrosion Test: Low

Tested to J-STD-004, IPC-TM-650, Method 2.6.15

Fluorides by Spot Test: Pass

Tested to J-STD-004, IPC-TM-650, Method 2.3.35.1

Surface Insulation Resistance (SIR) (Typical): Pass Tested to J-STD-004, IPC-TM-650, Method 2.6.3.3

	Blank	EM907
Day 1	1.1*10 ¹⁰ Ω	7.7*10 ⁸ Ω
Day 4	1.5*10 ¹⁰ Ω	1.2*10 ⁹ Ω
Day 7	1.4*10 ¹⁰ Ω	1.4*10 ⁹ Ω

Availability

EM907 is available in the Sn96.5Ag3.0Cu0.5 and Sn96.5Ag3.5 alloys. Type 3 powder mesh is normally recommended, but type 4 is available for fine pitch applications. EM907 is also compatible with other SnAgCu alloys in a similar melting range to the listed alloys. For specific packaging information, see Kester's Paste Packaging Chart for available sizes. The appropriate combination depends on process variables and the specific application.

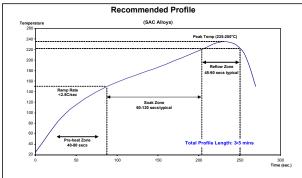




Printing Parameters

Squeegee Blade	80 to 90 durometer polyurethane or stainless steel	
Squeegee Speed	Capable to a maximum speed of 150 mm/sec (6 in/sec)	
Stencil Material	Stainless Steel, Molybdenum, Nickel Plated, Brass	
Temperature/Humidity	Optimal ranges are 21 to 25 $^\circ\text{C}$ (70 to 77 $^\circ\text{F}) and 35 to 65% RH$	

Recommended Reflow Profile



Full convection reflow method is most commonly used to reflow the EM907 formula. The recommended convection reflow profile for EM907 made with either the Sn96.5Ag3.5 or SnAgCu alloys is shown here.

Cleaning

EM907 is a no-clean formula. The residues do not need to be removed for typical applications. Although EM907 is designed for no-clean applications, its residues can be easily removed using automated cleaning equipment (in-line or batch) with a variety of readily available cleaning agents. Call Kester Technical Support for details.





Storage, Handling and Shelf Life

Refrigeration is the recommended optimum storage condition for solder paste to maintain consistent viscosity, reflow characteristics, and overall performance. EM907 should be stabilized at room temperature prior to printing. EM907 should be kept at standard refrigeration temperatures, 0 to 10 °C (32 to 50 °F). Please contact Kester Technical Support if you require additional advice with regard to storage and handling of this material. Shelf life is 4 months from date of manufacture and held at 0 to 10 °C (32 to 50 °F).

Health and Safety

This product, during handling or use, may be hazardous to your health or the environment. Read the Safety Data Sheet and warning label before using this product. Safety Data Sheets are available at <u>https://www.kester.com/downloads/sds</u>.

Contact Information

To confirm this document is the most recent version, please contact <u>Assembly@MacDermidAlpha.com</u>

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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE. Emergency safety directory assistance: US 1 202 464 2554, Europe + 44 1235 239 670, Asia + 65 3158 1074, Brazil 0800 707 7022 and 0800 172 020, Mexico 01800 002 1400 and (55) 5559 1588

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